

Dkt. No.: OP-093000197

AMENDMENTS TO THE CLAIMS:

1. (Currently amended) A heat dissipating structure for a computer host, comprising:
a casing having a front side, a back side, a left side and a right side;
a mother board having a CPU, plural electrical components mounted thereon;
a first heat dissipating fin module and a second heat dissipating fin module mounted to each to form a heat dissipating device mounted on the CPU for dissipating heat generated therefrom,

wherein the left side and the right side respectively have a left side board and a right side board for opening thereon plural ventilative openings corresponding to each other, and the plural ventilative openings on respective left side board and right side board are opened at positions facing the heat dissipating device.

2. (Cancelled)

3. (Currently amended) The heat dissipating structure for a computer host according to claim ~~[[2]]~~1, wherein two outside surfaces of the first heat dissipating fin module and the second heat dissipating fin module have a first heat dissipating fan and a second heat dissipating fan mounted thereon facing towards the ventilative openings respectively.

4. (Currently amended) The heat dissipating structure for a computer host according to claim 3, wherein the first heat dissipating fan and the second heat dissipating fan are rotated at the same direction to draw wind outside the case from the right side/left side flowing through the heat dissipating device and taking heat from the CPU to flow outside from the left side/right side.

5. (New) A heat dissipating structure for a computer host, comprising:

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a casing having a front side, a back side, a left side and a right side;
a mother board having a CPU, plural electrical components mounted thereon;
a heat dissipating device mounted on the CPU for dissipating heat generated therefrom;
and

a dissipating fan mounted on the heat dissipating device,

wherein the left side and the right side respectively have a left side board and a right side board for opening thereon plural ventilative openings corresponding to each other, and the plural ventilative openings on respective left side board and right side board are opened at positions facing the heat dissipating device, and

wherein the dissipating fan faces towards the plural ventilative openings to draw wind outside the case from the right side/left side flowing through the heat dissipating device and taking heat from the CPU to flow outside from the left side/right side.

6. (New) The heat dissipating structure for a computer host according to claim 5, wherein the heat dissipating device comprises a first heat dissipating fin module and a second heat dissipating fin module mounted to each other to mount on the CPU.

7. (New) The heat dissipating structure for a computer host according to claim 6, wherein the dissipating fan includes a first heat dissipating fan and a second heat dissipating fan mounted on two outside surfaces of the first heat dissipating fin module and the second heat dissipating fin module respectively.

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